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Fairchild Semiconductor FCH043N60

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Distributor of Fairchild Semiconductor: Excellent Integrated System Limited Datasheet of FCH043N60 - MOSFET N-CH 600V 75A TO247 Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

Description

miniaturization and higher efficiency.



FCH043N60 N-Channel SuperFET[®] II MOSFET

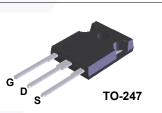
600 V, 75 A, 43 m Ω

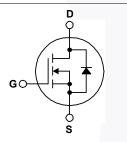
Features

- 650 V @ T_J = 150°C
- Typ. R_{DS(on)} = 37 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 163 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 730 pF)
- 100% Avalanche Tested
- RoHS Compliant

Applications

- Telecom / Sever Power Supplies
- Industrial Power Supplies





SuperFET® II MOSFET is Fairchild Semiconductor's brand-new

high voltage super-junction (SJ) MOSFET family that is utilizing

charge balance technology for outstanding low on-resistance

and lower gate charge performance. This advanced technology

is tailored to minimize conduction loss, provide superior

switching performance, and withstand extreme dv/dt rate and

higher avalanche energy. Consequently, SuperFET II MOSFET is suitable for various AC/DC power conversion for system

Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

| Symbol | | FCH043N60 | Unit | | | |
|-----------------------------------|---|--|---------------------------------------|-------------|-------------------|--|
| V _{DSS} | Drain to Source Voltage | | 600 | V | | |
| V _{GSS} | Gate to Source Voltage | - DC | | ±20 | V | |
| | | - AC | (f > 1 Hz) | ±30 | v | |
| I _D | Drain Current | - Continuous (T _C = 25 ^o C) | | 75 | A | |
| | | - Continuous (T _C = 100 ^o C) | | 47.5 | | |
| I _{DM} | Drain Current | - Pulsed | (Note 1) | 225 | А | |
| E _{AS} | Single Pulsed Avalanche Energy (Note 2) | | | 2025 | mJ | |
| I _{AR} | Avalanche Current | (Note 1) | 15 | A | | |
| E _{AR} | Repetitive Avalanche Energy | (Note 1) | 5.92 | mJ | | |
| dv/dt | MOSFET dv/dt | | 100 | V/ns | | |
| | Peak Diode Recovery dv/dt | (Note 3) | 20 | v/ns | | |
| P _D | Power Dissipation | (T _C = 25°C) | | 592 | W | |
| | | - Derate Above 25°C | · · · · · · · · · · · · · · · · · · · | 4.74 | W/ ^o C | |
| T _J , T _{STG} | Operating and Storage Temperature Range | | | -55 to +150 | °C | |
| TL | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds | | | 300 | °C | |

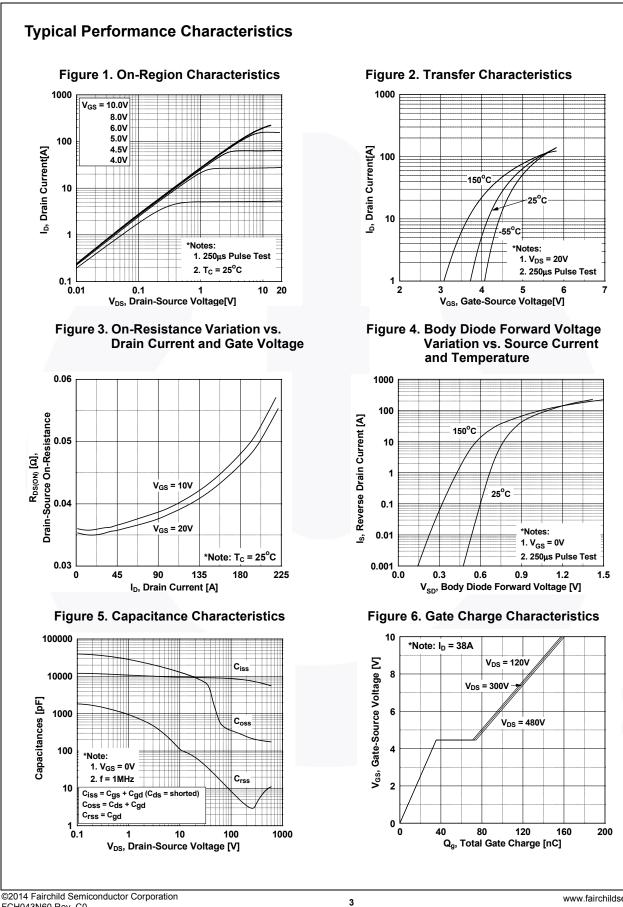
Thermal Characteristics

| Symbol | Parameter | FCH043N60 | Unit | |
|-----------------|---|-----------|-------|--|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 0.21 | °C/W | |
| R_{\thetaJA} | Thermal Resistance, Junction to Ambient, Max. | 40 | -0/00 | |



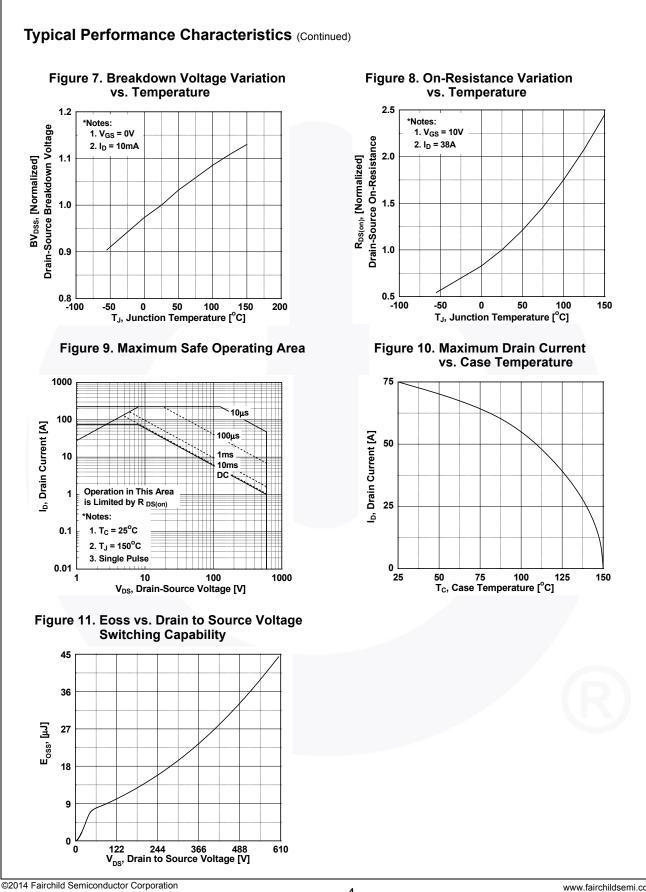
| nber | Top Mark | Package | Packing Method | Reel Siz | e | Tape Wid | th Qu | uantity | |
|--|---|---|---|---|--|---|---|---|--|
| FCH043N60 FCH043N60 T | | TO-247 | O-247 Tube N/A | | | N/A | 30 | 30 units | |
| l Chara | acteristics T _C = 25°C | C unless oth | nerwise noted. | | | | | | |
| Symbol Parameter | | | Test Conditions | | | Тур. | Max. | Unit | |
| teristics | 5 | | | | | | | | |
| Drain to Source Breakdown Voltage | | I _D = 1 | 10 mA, V _{GS} = 0 V, T _C | = 25°C | 600 | - | - | | |
| | | <u> </u> | $I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}, T_C = 150^{\circ}\text{C}$ | | | - | - | V | |
| Breakdown Voltage Temperature Coefficient | | I _D = 1 | $I_D = 10 \text{ mA}$, Referenced to $25^{\circ}C$ | | | 0.67 | - | V/ºC | |
| Zero Gate Voltage Drain Current | | | V _{DS} = 600 V, V _{GS} = 0 V | | - | - 1 | 1 | μA | |
| | | | | _C = 125°C | - | 4.5 | - | • | |
| Gate to Body Leakage Current | | V _{GS} = | = ±20 V, V _{DS} = 0 V | | - | - | ±100 | nA | |
| teristics | 5 | | | | | | | | |
| Gate Threshold Voltage | | V _{GS} = | = V _{DS} , I _D = 250 μA | | 2.5 | - | 3.5 | V | |
| Static Drain to Source On Resistance | | | | | - | 37 | 43 | mΩ | |
| Forward Transconductance | | | V _{DS} = 20 V, I _D = 38 A | | | 73 | - | S | |
| haracto | ristics | | | | | | | | |
| - | | | | | | 0104 | 10005 | ~ [| |
| | | V _{DS} = | V _{DS} = 400 V, V _{GS} = 0 V, f = 1 MHz | | _ | | - | pF pF | |
| - | | f = 1 | | | _ | | | pr | |
| | | Vpc = | = 0 V to 480 V Voc = | 0 V | | | | pF | |
| | | | | - | 163 | 215 | nC | | |
| | | V _{DS} = | = 10 V | | - | 35 | - | nC | |
| Gate to I | Drain "Miller" Charge | 00 | | (Note 4) | - | 39 | - | nC | |
| Equivale | nt Series Resistance | f = 1 | MHz | | - | 1.1 | - | Ω | |
| Charact | teristics | | | | | | | | |
| Turn-On | Delay Time | | | | - | 46 | 102 | ns | |
| Turn-On | Rise Time | | V _{DD} = 380 V, I _D = 38 A, | | - | 36 | 82 | ns | |
| Turn-Off | Delay Time | V _{GS} = | = 10 V, R_{G} = 4.7 Ω | Ω | | 162 | 334 | ns | |
| Turn-Off | Fall Time | | | (Note 4) | - | 6 | - | ns | |
| rce Diod | le Characteristics | | | | | | | | |
| 1 | | rce Diode F | orward Current | | | _ | 75 | А | |
| | | | | | | - | | A | |
| | | | | | - | - | 1.2 | V | |
| | | | $V_{GS} = 0 V, I_{SD} = 38 A,$ dI _F /dt = 100 A/ μ s | | - | 605 | - | ns | |
| Reverse | Recovery Charge | | | | - | 16 | - | μC | |
| | teristics Drain to Breakdo Coefficie Zero Gat Gate to R teristics Gate Thu Static Dr Forward haracte Input Ca Output C Reverse Effective Total Gat Gate to R Equivale Charact Turn-On Turn-Off Turn-Off Turn-Off Ce Diod Maximun Drain to S Reverse | Parameter teristics Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Body Leakage Current teristics Gate Threshold Voltage Static Drain to Source On Resistand Forward Transconductance *haracteristics Input Capacitance Output Capacitance Output Capacitance Effective Output Capacitance Effective Output Capacitance Gate to Drain "Miller" Charge Equivalent Series Resistance Characteristics Turn-On Delay Time Turn-Off Delay Time Turn-Off Fall Time ce Diode Characteristics Maximum Continuous Drain to Source D | ParameterteristicsDrain to Source Breakdown Voltage $I_D = 1$ $I_D = 1$ Breakdown Voltage Temperature Coefficient $I_D = 1$ Zero Gate Voltage Drain Current $V_{DS} = 1$ 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Pulsed Drain to Source Diode Forward Voltage $V_{GS} = 1$ Maximum Pulsed Drain to Source Diode Forward V | teristicsDrain to Source Breakdown Voltage $I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}, T_C$ $I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}, T_C$ Breakdown Voltage Temperature Coefficient $I_D = 10 \text{ mA}, \text{ Referenced to}$ Zero Gate Voltage Drain Current $V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}$ Gate to Body Leakage Current $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ teristics $V_{GS} = V_{DS}, I_D = 250 \mu \text{A}$ Static Drain to Source On Resistance $V_{GS} = 10 \text{ V}, I_D = 38 \text{ A}$ Forward Transconductance $V_{DS} = 20 \text{ V}, I_D = 38 \text{ A}$ haracteristics $V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ Input Capacitance $V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ Reverse Transfer Capacitance $V_{DS} = 0 \text{ V}$ to $480 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ Characteristics $V_{DS} = 380 \text{ V}, I_D = 38 \text{ A}, V_{GS} = 10 \text{ V}$ Gate to Drain "Miller" Charge $V_{DD} = 380 \text{ V}, I_D = 38 \text{ A}, V_{GS} = 10 \text{ V}$ Equivalent Series Resistance $f = 1 \text{ MHz}$ Characteristics $V_{DD} = 380 \text{ V}, I_D = 38 \text{ A}, V_{GS} = 10 \text{ V}, R_G = 4.7 \Omega$ Turn-On Delay Time Turn-Off Delay Time $V_{GS} = 10 \text{ V}, R_G = 4.7 \Omega$ Turn-Off Fall Time $V_{GS} = 0 \text{ V}, I_{SD} = 38 \text{ A}, V_{GS} = 10 \text{ V}, R_G = 4.7 \Omega$ Maximum Continuous Drain to Source Diode Forward CurrentMaximum Pulsed Drain to Source Diode Forward CurrentMaximum Pulsed Drain to Source Diode Forward CurrentDrain to Source Diode Forward CurrentDrain to Source Diode Forward Voltage $V_{GS} = 0 \text{ V}, I_{SD} = 38 \text{ A},$ | ParameterTest ConditionsteristicsDrain to Source Breakdown Voltage $I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}, T_C = 25^{\circ}\text{C}$ Breakdown Voltage Temperature Coefficient $I_D = 10 \text{ mA}, \text{ V}_{GS} = 0 \text{ V}, T_C = 150^{\circ}\text{C}$ Breakdown Voltage Temperature Coefficient $I_D = 10 \text{ mA}, \text{ Referenced to } 25^{\circ}\text{C}$ Zero Gate Voltage Drain Current $V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$ Gate to Body Leakage Current $V_{GS} = 480 \text{ V}, V_{GS} = 0 \text{ V}$ teristicsGate Threshold Voltage $V_{GS} = 10 \text{ V}, I_D = 38 \text{ A}$ Forward Transconductance $V_{DS} = 20 \text{ V}, I_D = 38 \text{ A}$ Forward Transconductance $V_{DS} = 20 \text{ V}, I_D = 38 \text{ A}$ Input Capacitance Dutput Capacitance $V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V},$ Effective Output Capacitance $V_{DS} = 0 \text{ V}$ to $480 \text{ V}, V_{GS} = 0 \text{ V},$ feate to Source Gate Charge Gate to Drain "Miller" Charge $V_{DS} = 10 \text{ V}, I_D = 38 \text{ A},$ Gate to Drain "Miller" Charge $(Note 4)$ Equivalent Series Resistance $f = 1 \text{ MHz}$ CharacteristicsTurn-On Delay Time Turn-Off Belay TimeTurn-Off Delay Time $V_{DD} = 380 \text{ V}, I_D = 38 \text{ A},$ VGS = 10 V, R_G = 4.7 \OmegaTurn-Off Fall Time $(Note 4)$ Choide CharacteristicsMaximum Continuous Drain to Source Diode Forward CurrentMaximum Pulsed Drain to Source Diode Forward CurrentMaximum Pulsed Drain to Source Diode Forward CurrentDrain to Source Diode Forward VoltageVGS = 0 V, I_SD = 38 A,Reverse Recovery T | $\begin{tabular}{ c $ | $\begin{tabular}{ c c c c c } \hline Parameter & Test Conditions & Min. Typ. \\ \hline teristics \\ \hline train to Source Breakdown Voltage $$ l_{D} = 10 mA, V_{GS} = 0 V, T_{C} = 25^{\circ}C & 600 & - \\ l_{D} = 10 mA, V_{GS} = 0 V, T_{C} = 150^{\circ}C & 650 & - \\ \hline l_{D} = 10 mA, V_{GS} = 0 V, T_{C} = 150^{\circ}C & - & 0.67 \\ \hline Coefficient & V_{DS} = 600 V, V_{GS} = 0 V & - & - \\ \hline V_{DS} = 600 V, V_{GS} = 0 V & - & - \\ \hline V_{DS} = 480 V, V_{GS} = 0 V, T_{C} = 125^{\circ}C & - & 4.5 \\ \hline Gate to Body Leakage Current & V_{GS} = \pm 20 V, V_{DS} = 0 V & - & - \\ \hline teristics & & & & & & & & & & & & & & & & & & &$ | $\begin{tabular}{ c c c c c c c } \hline Parameter & Test Conditions & Min. Typ. Max. \\ \hline teristics \\ \hline teristics \\ \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$ | |





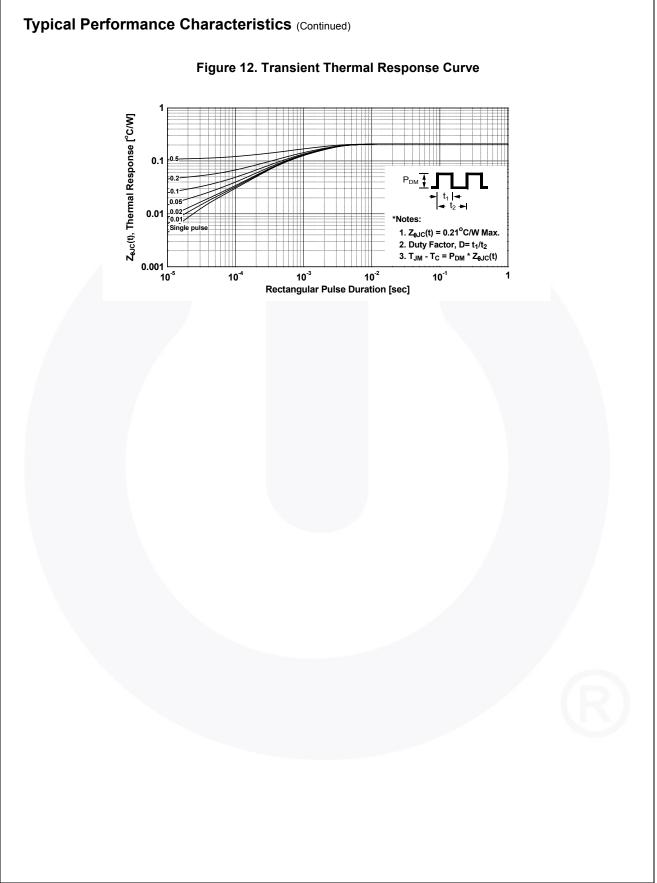
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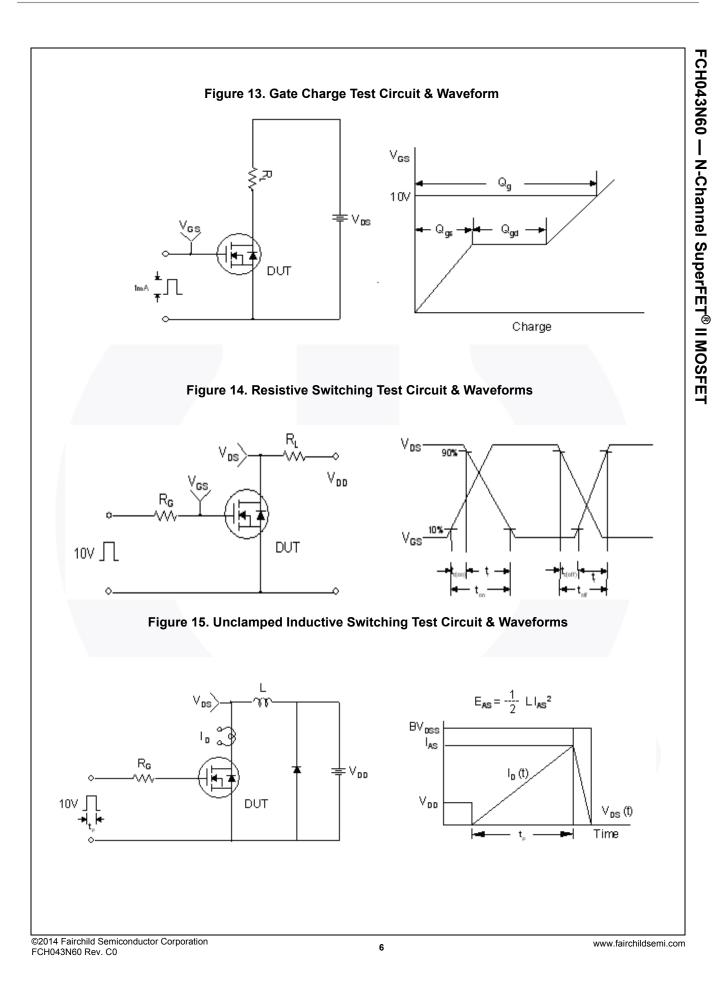


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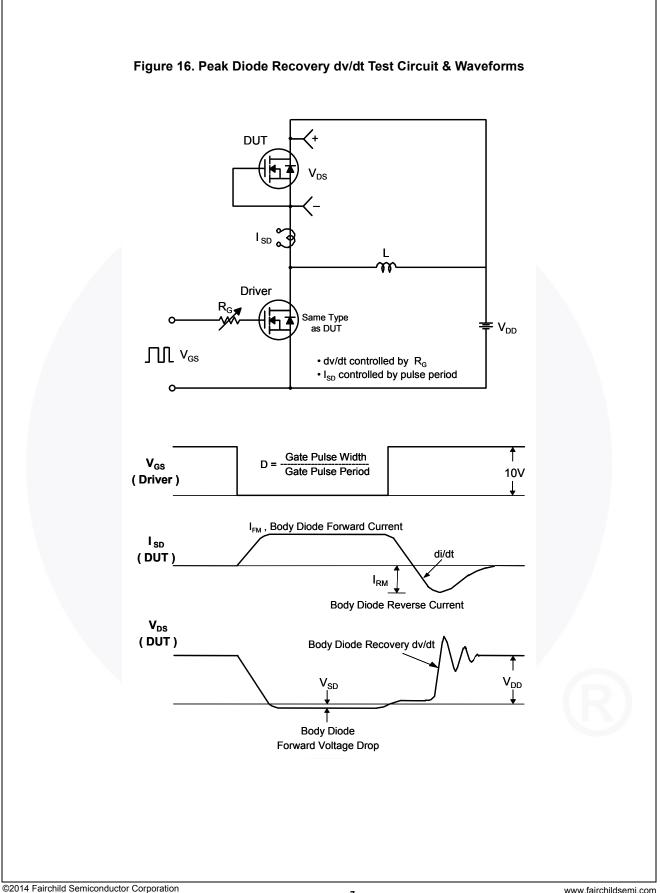








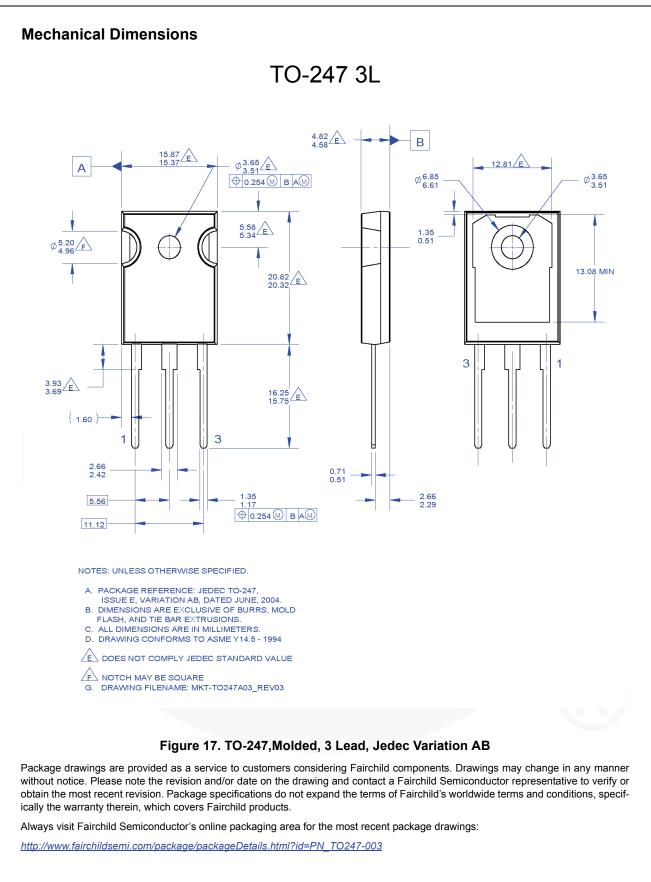




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